



# Product Change Notification

**Change Notification #:** 114766 - 01  
**Change Title:** Intel® Server Board S2600WTTR,  
PCN 114766-01, Product Design,  
DIMM connector change,  
**Reason for Revision: Remove TA  
numbers from Products Affected table**  
**Date of Publication:** July 14, 2016

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	Jul 17, 2016
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

### Reason for Revision: Remove TA numbers from Products Affected table

Intel is implementing the following change on the Intel® Server Boards S2600WTTR.

- Replaced DIMM connector to increase gold plating thickness from 15u" to 30u" for higher durability

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change PBA	Post Change PBA
S2600WTTR	943785	G92187-366	G92187-367

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
July 12, 2016	00	Originally Published PCN
July 14, 2016	01	Remove TA numbers from Products Affected table



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## 114766 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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